PCN Number:		20200107000			PCN Date:	Ja	Jan. 7, 2020		
Title:	Datasheet fo	r LM36	568-Q1						
Custome	er Contact:	PCN	Manage	er		D)ept	t:	Quality Services
Change [*]	Туре:								
Assembly Site				Design			Wafer	Bump Site	
			Data Sheet		Wafer Bump Material				
Assembly Materials					Part number change			Wafer	Bump Process
Mechanical Specification					Test Site				Fab Site
Packing/Shipping/Labeling				Test Process		Wafer Fab Materials			
						Wafer Fab Process			
Notification Details									
Description of Change:									
Texas Instruments Incorporated is announcing an information only notification. The product datasheet(s) is being updated as summarized below. The following change history provides further details.									
	STRUMENTS								LM3668-Q1
SNVSA84B – APRIL 2015–REVISED JANUARY 2020									
Changes from Revision A (May 2015) to Revision B Page									
Changed I _{SHDN} to T _A = 25°C in the <i>Electrical Characteristics</i>									
	sheet number	will be	e chang	jing					
Device F				Change From:		Change To:			
LM3668	LM3668-Q1			SNVSA84A		SNVSA84B			
The document is not available on the TI website. Please contact the TI Customer Quality Engineer (CQE) for a copy of the datasheet.									
Reason for Change:									
To accurately reflect device characteristics.									
Anticipated impact on Fit, Form, Function, Quality or Reliability (positive / negative):									
No anticipated impact. This is a specification change announcement only. There are no changes									
to the actual device.									
Changes to product identification resulting from this PCN:									
None.									
Product Affected:									
LM36680									

For questions regarding this notice, e-mails can be sent to the contacts shown below or your local Field Sales Representative.

Location	E-Mail
USA	PCNAmericasContact@list.ti.com
Europe	PCNEuropeContact@list.ti.com
Asia Pacific	PCNAsiaContact@list.ti.com
WW PCN Team	PCN ww admin team@list.ti.com

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